

DATA SHEET



Solid State Relay
OCMOS FET

PS7522-1A,-2A,PS7522L-1A,-2A

**6, 8-PIN DIP, SLOW SWITCHING TYPE
1-ch, 2-ch Optical Coupled MOS FET**

DESCRIPTION

The PS7522-1A, -2A and PS7522L-1A, -2A are solid state relays containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

They are suitable for equipments which are necessary to prevent some noise, because of their slow switching speed at turn-on or turn-off.

The PS7522L-1A, -2A have a surface mount type lead.

★ FEATURES

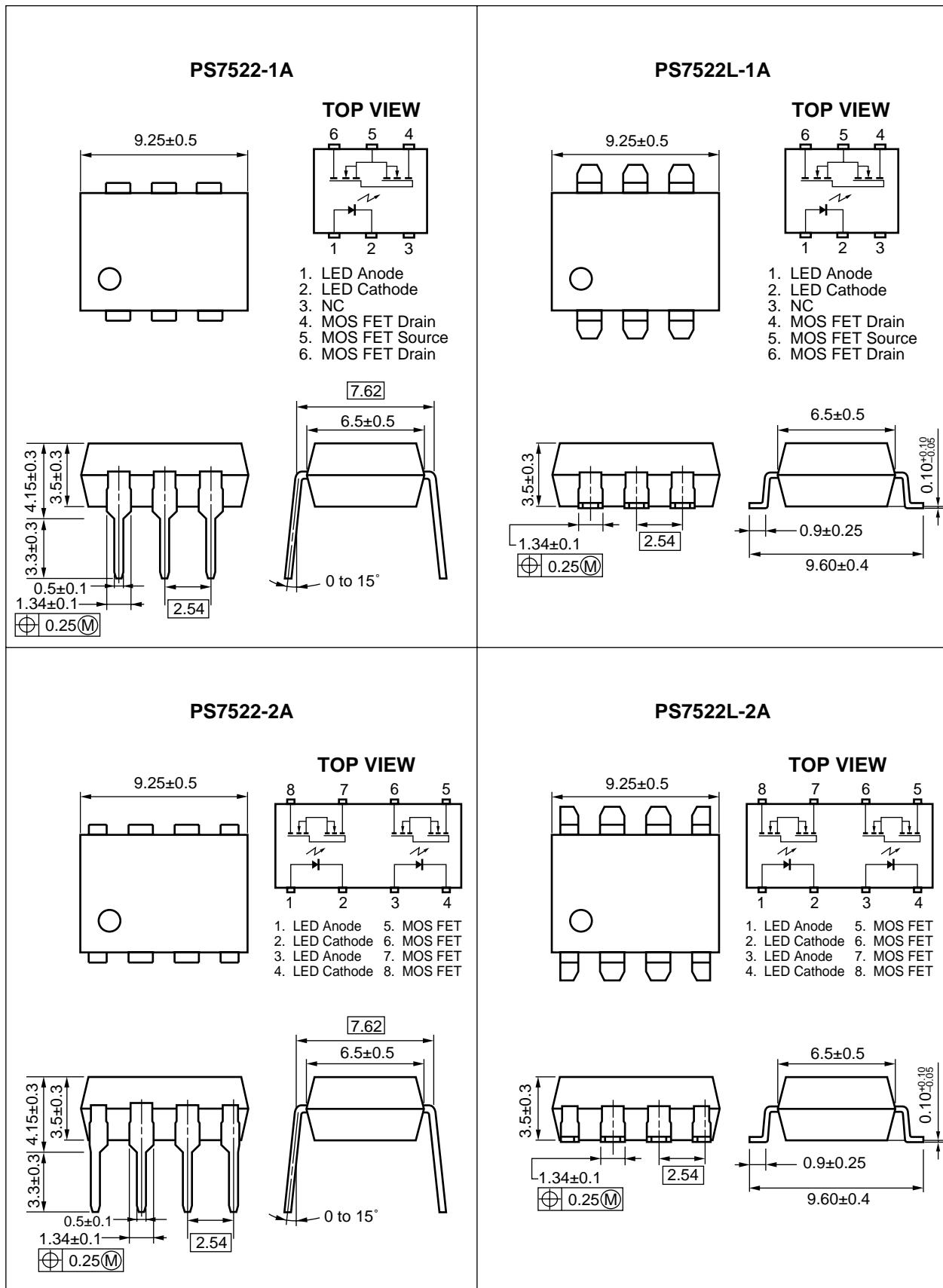
- 1 channel type (1 a output) or 2 channel type (1 a + 1 a output)
- Low LED operating current ($I_F = 1 \text{ mA}$)
- Designed for AC/DC switching line changer
- Small package (6, 8-pin DIP)
- Slow turn-on time, slow turn-off time ($t_{on} = 12 \text{ ms MAX.}$, $t_{off} = 6.5 \text{ ms MAX.}$)
- Low offset voltage
- PS7522L-1A, -2A: Surface mount type
- UL approved: File No. E72422 (S)
- BSI approved: No. 8245/8246
- CSA approved: No. CA 101391

APPLICATIONS

- Exchange equipment
- Measurement equipment
- FA/OA equipment

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

PACKAGE DIMENSIONS (in millimeters)



★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number ^{*1}
PS7522-1A	6-pin DIP	Magazine case 50 pcs	PS7522-1A
PS7522L-1A		Embossed Tape 1 000 pcs/reel	PS7522L-1A
PS7522L-1A-E3	8-pin DIP	Magazine case 50 pcs	PS7522-2A
PS7522L-1A-E4		Embossed Tape 1 000 pcs/reel	PS7522L-2A
PS7522-2A	8-pin DIP	Magazine case 50 pcs	PS7522-2A
PS7522L-2A		Embossed Tape 1 000 pcs/reel	PS7522L-2A
PS7522L-2A-E3			
PS7522L-2A-E4			

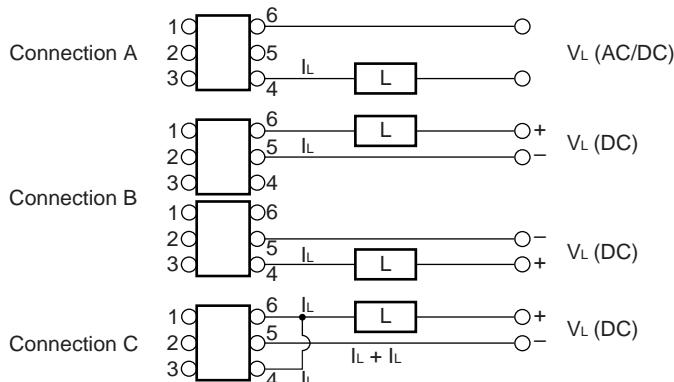
*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

Parameter		Symbol	Ratings		Unit
			PS7522-1A, PS7522L-1A	PS7522-2A, PS7522L-2A	
Diode	Forward Current (DC)	I_F	50		mA
	Reverse Voltage	V_R	5.0		V
	Power Dissipation	P_D	50		mW/ch
	Peak Forward Current ¹	I_{FP}	1		A
MOS FET	Break Down Voltage	V_L	200		V
	Continuous	I_L	200		mA
	Load Current ²		350	—	
	Connection A		400	—	
	Connection B				
	Connection C				
Pulse Load Current ³ (AC/DC Connection)	I_{LP}	400			mA
	P_D	560	375		mW/ch
Isolation Voltage ⁴		BV	1 500		Vr.m.s.
Total Power Dissipation		P_T	610	850	mW
Operating Ambient Temperature		T_A	—40 to +80		°C
Storage Temperature		T_{stg}	—40 to +100		°C

*1 PW = 100 μs , Duty Cycle = 1 %

*2 Conditions: $I_F \geq 2$ mA. The following types of load connections are available.



*3 PW = 100 ms, 1 shot

*4 AC voltage for 1 minute at $T_A = 25^\circ\text{C}$, RH = 60 % between input and output

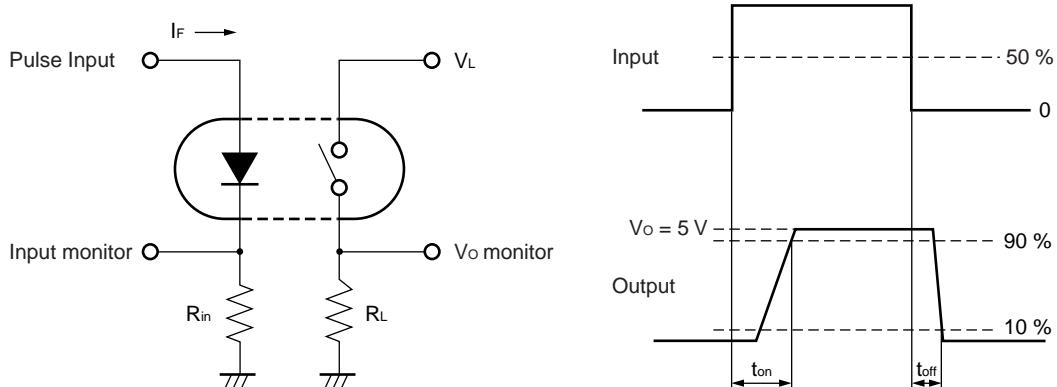
RECOMMENDED OPERATING CONDITIONS ($T_A = 25^\circ\text{C}$)

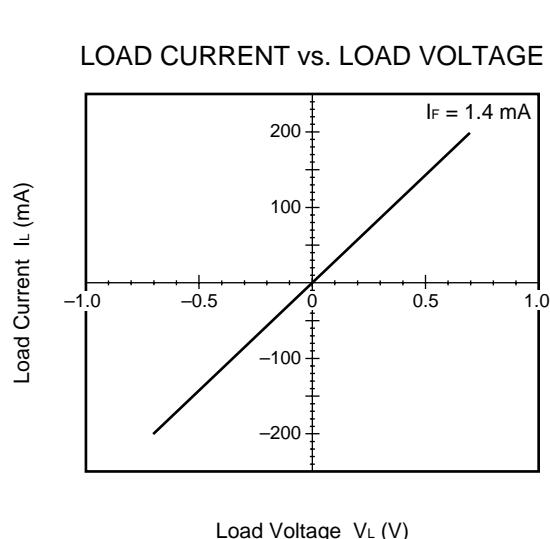
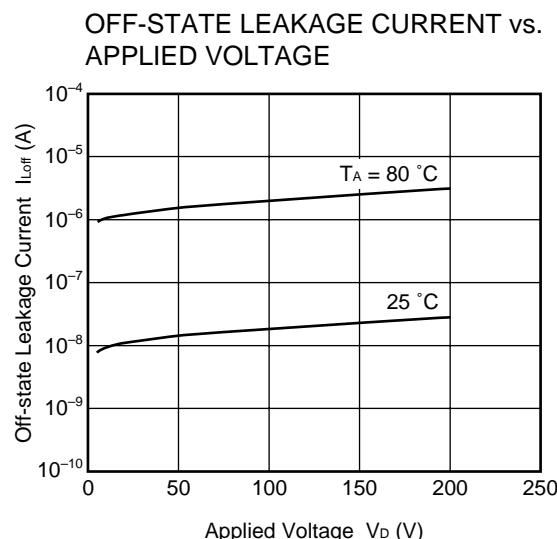
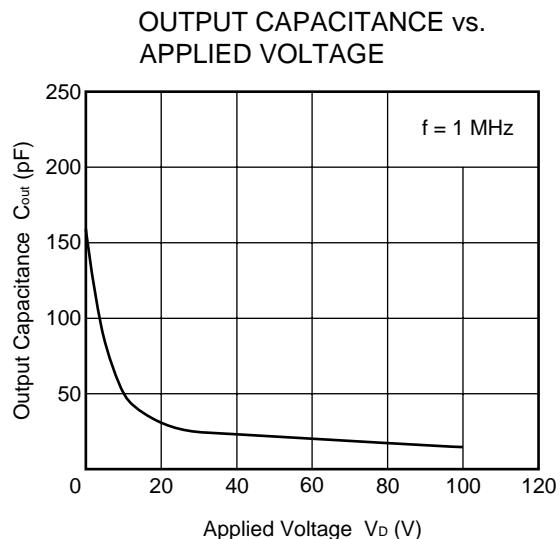
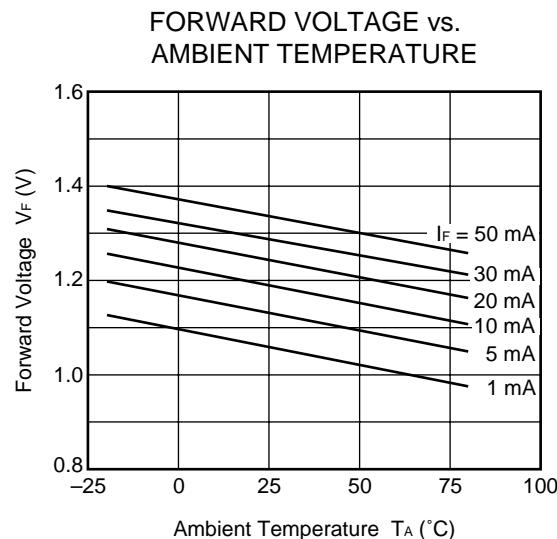
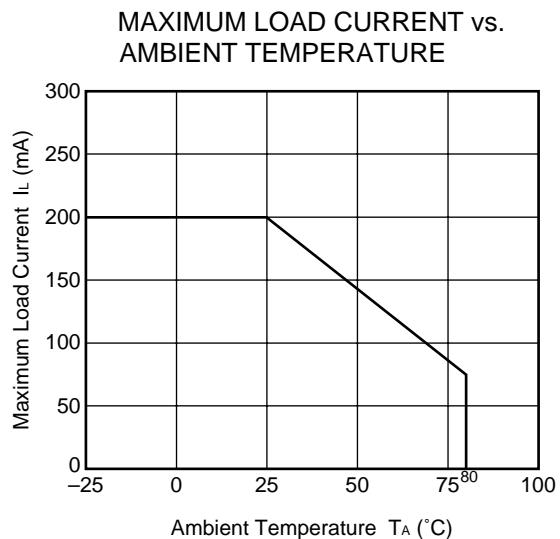
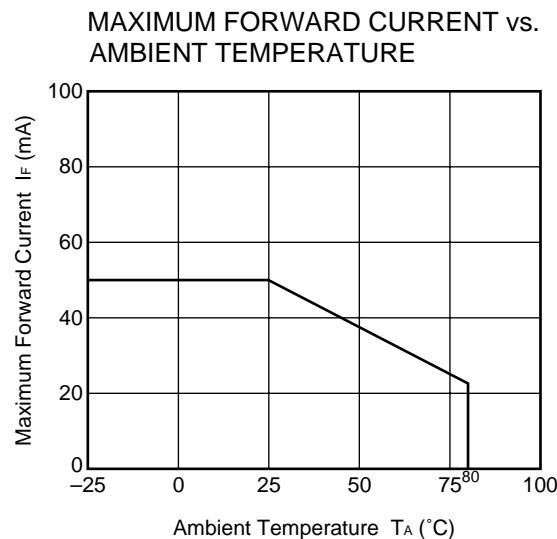
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	1	10	20	mA
LED Off Voltage	V_F	0		0.5	V

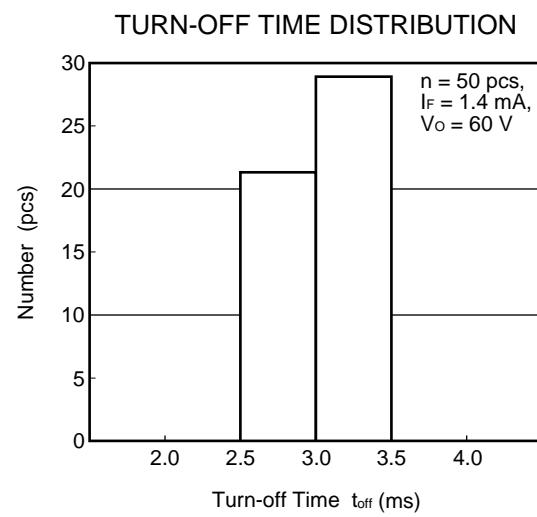
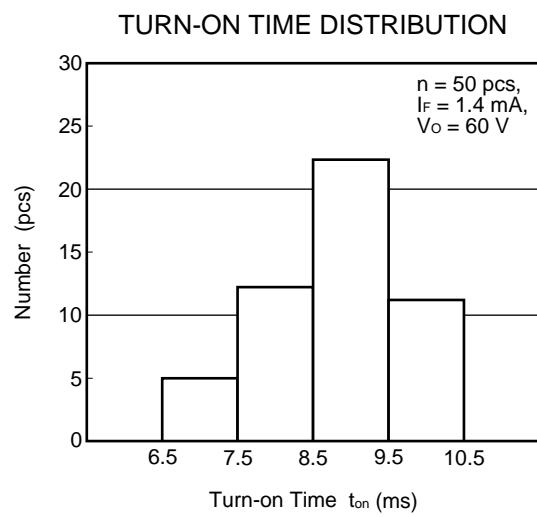
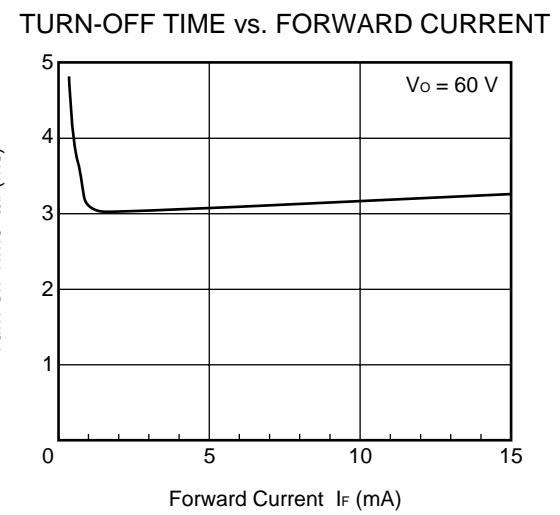
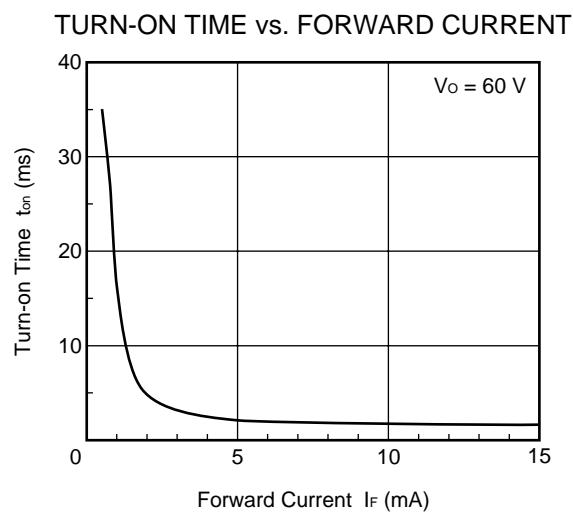
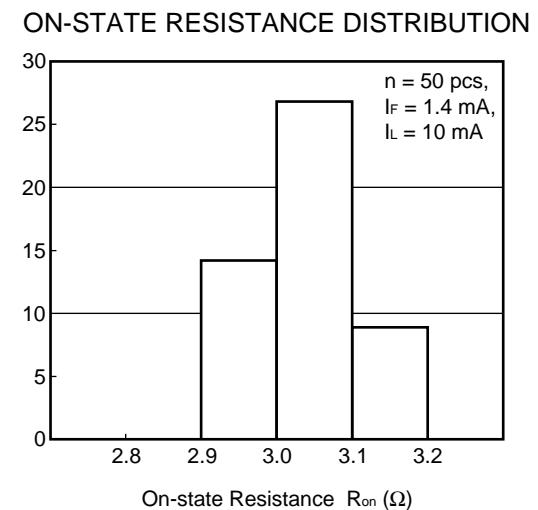
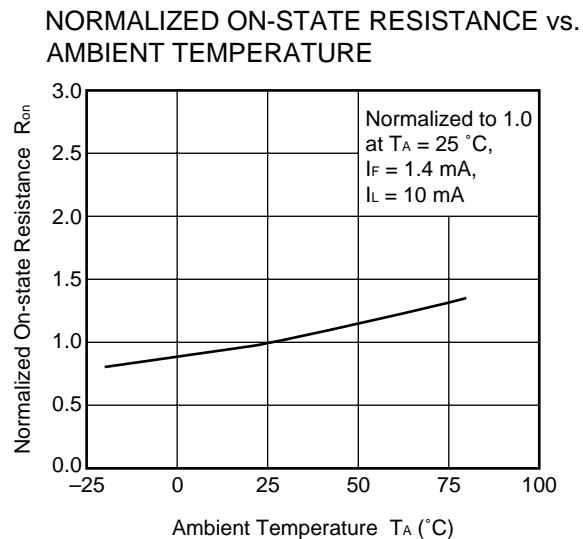
★ ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

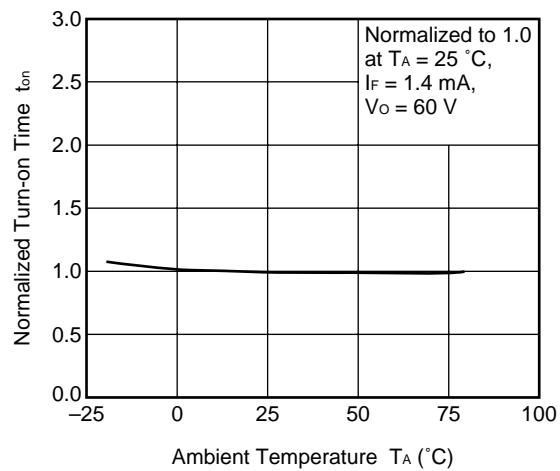
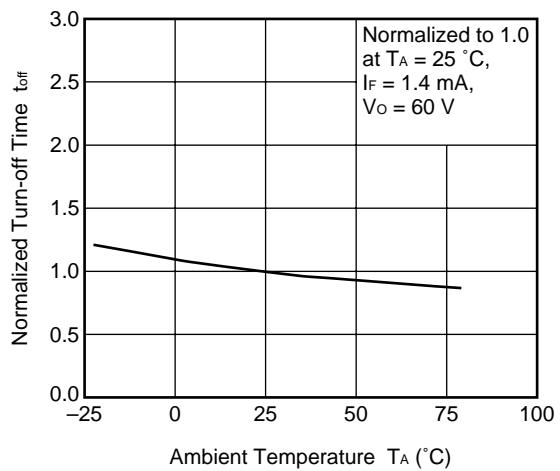
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	$I_F = 1.4 \text{ mA}$		1.1	1.4	V
	Reverse Current	I_R	$V_R = 5 \text{ V}$			5.0	μA
MOS FET	Off-state Leakage Current	I_{loff}	$V_D = 200 \text{ V}$		0.03	1.0	μA
	Output Capacitance	C_{out}	$V_D = 0 \text{ V}, f = 1 \text{ MHz}$		165		pF/ch
Coupled	LED On-state Current	I_{Fon}	$I_L = 200 \text{ mA}$			1.0	mA
	On-state Resistance	R_{on1}	$I_F = 1.4 \text{ mA}, I_L = 10 \text{ mA}$		3.0	5.0	Ω
		R_{on2}	$I_F = 10 \text{ mA}, I_L = 200 \text{ mA}, t \leq 20 \text{ ms}$				
	Turn-on Time ¹	t_{on}	$I_F = 1.4 \text{ mA}, V_O = 60 \text{ V}, PW \geq 50 \text{ ms}$		8.5	12	ms
	Rise Time	t_r		0.80	2.78		
	Turn-off Time ¹	t_{off}			3.0	6.5	
	Fall Time	t_f		0.4	0.8		
	Isolation Resistance	$R_{\text{I-O}}$	$V_{\text{I-O}} = 1.0 \text{ kV}_{\text{DC}}$	10^9			Ω
	Isolation Capacitance	$C_{\text{I-O}}$	$V = 0 \text{ V}, f = 1 \text{ MHz}$		1.1		pF/ch

*1 Test Circuit for Switching Time



★ TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

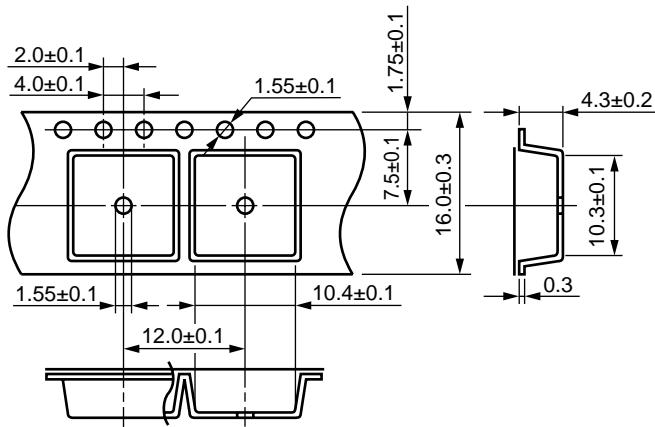


NORMALIZED TURN-ON TIME vs.
AMBIENT TEMPERATURENORMALIZED TURN-OFF TIME vs.
AMBIENT TEMPERATURE

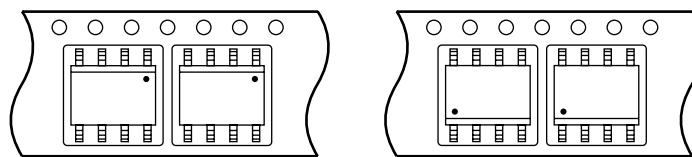
Remark The graphs indicate nominal characteristics.

★ TAPING SPECIFICATIONS (in millimeters)

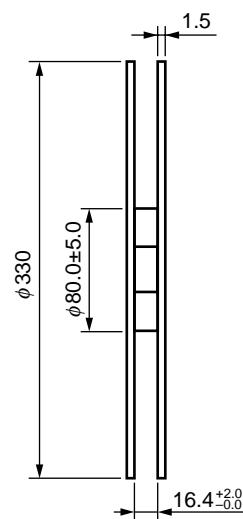
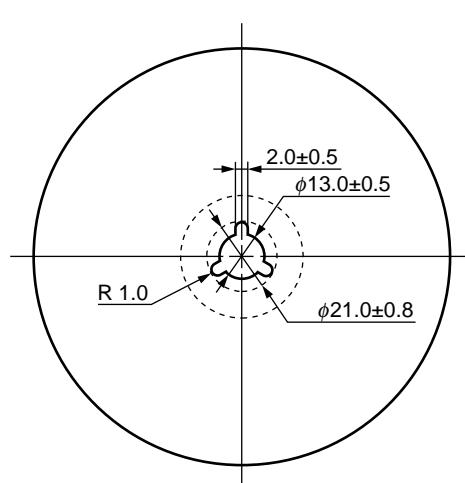
Outline and Dimensions (Tape)



Tape Direction

PS7522L-1A-E3
PS7522L-2A-E3PS7522L-1A-E4
PS7522L-2A-E4

Outline and Dimensions (Reel)



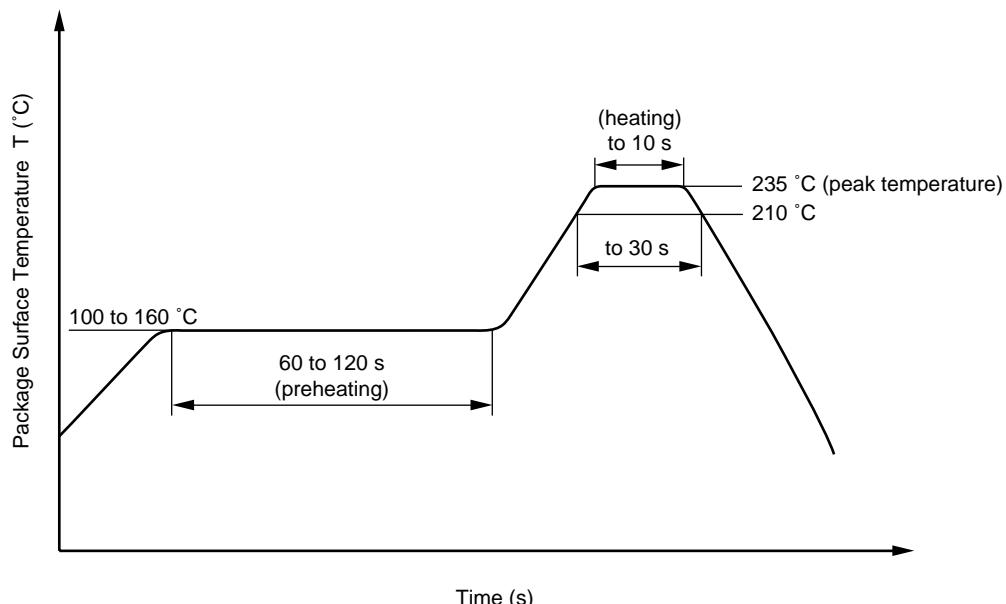
Packing: 1 000 pcs/reel

RECOMMENDED SOLDERING CONDITIONS**(1) Infrared reflow soldering**

- Peak reflow temperature 235 °C (package surface temperature)
- Time of temperature higher than 210 °C 30 seconds or less
- Number of reflows Two
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

★

Recommended Temperature Profile of Infrared Reflow

**(2) Dip soldering**

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

- Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

[MEMO]

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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